ne<mark>x</mark>peria

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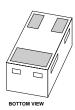
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Kind regards,

Team Nexperia



40 V, 200 mA PNP switching transistor

Rev. 01 — 22 July 2009

Product data sheet

1. Product profile

1.1 General description

PNP single switching transistor in a SOT883 (SC-101) leadless ultra small Surface-Mounted Device (SMD) plastic package.

NPN complement: PMBT3904M.

1.2 Features

- Single general-purpose switching transistor
- Board-space reduction
- AEC-Q101 qualified
- Ultra small SMD plastic package

1.3 Applications

General-purpose switching and amplification

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-40	V
I _C	collector current		-	-	-200	mA
h _{FE}	DC current gain	$V_{CE} = -1 V;$ $I_{C} = -10 mA$	100	180	300	

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector	2	1
		Transparent top view	۱ ۳



40 V, 200 mA PNP switching transistor

3. Ordering information

Table 3. Ordering information							
Type number	Package	Package					
	Name	Description	Version				
PMBT3906M	SC-101	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5$ mm	SOT883				

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
PMBT390	6M	6Q

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

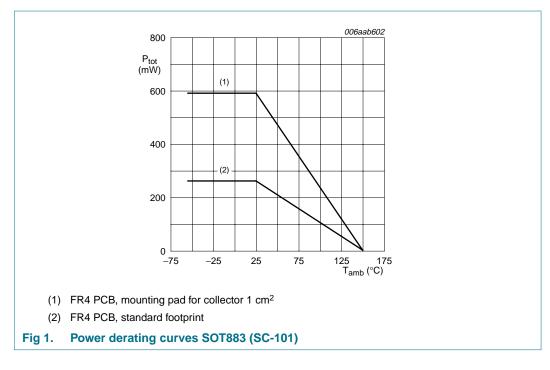
				-		
Symbol	Parameter	Conditions		Min	Мах	Unit
V _{CBO}	collector-base voltage	open emitter		-	-40	V
V_{CEO}	collector-emitter voltage	open base		-	-40	V
V_{EBO}	emitter-base voltage	open collector		-	-6	V
I _C	collector current			-	-200	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$		-	-200	mA
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms		-	-100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1][2]	-	260	mW
			[1][3]	-	590	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	+150	°C
T _{stg}	storage temperature			-65	+150	°C

[1] Reflow soldering is the only recommended soldering method.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

40 V, 200 mA PNP switching transistor



6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1][2] _	-	481	K/W
	junction to ambient		[1][3]	-	212	K/W

[1] Reflow soldering is the only recommended soldering method.

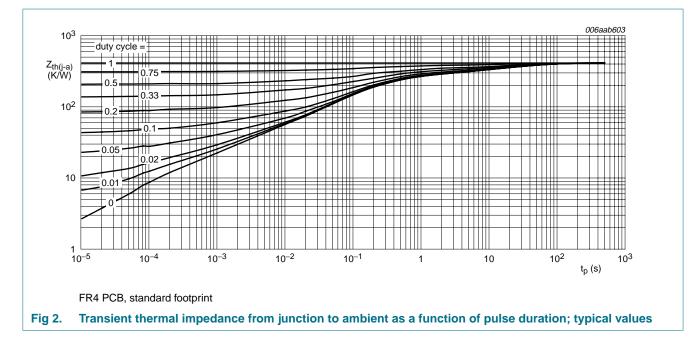
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

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PMBT3906M

40 V, 200 mA PNP switching transistor



7. Characteristics

Table 7.Characteristics

Τ _	2EOC	unlogo	otherwise	anaaifiad
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$V_{CB} = -30$ V; $I_E = 0$ A	-	-	-50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -6$ V; $I_{C} = 0$ A	-	-	-50	nA
h _{FE}	DC current gain	$V_{CE} = -1 V$				
		I _C = -0.1 mA	60	180	-	
		$I_{\rm C} = -1 \rm{mA}$	80	180	-	
		$I_{\rm C} = -10 {\rm mA}$	100	180	300	
		I _C = -50 mA	60	130	-	
		$I_{C} = -100 \text{ mA}$	30	50	-	
V _{CEsat}	at collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	-	-100	-250	mV
		$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	-	-165	-400	mV
V _{BEsat}	base-emitter	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	-	-750	-850	mV
	saturation voltage	$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	-	-850	-950	mV
t _d	delay time	$V_{CC} = -3 V;$	-	-	35	ns
t _r	rise time	$I_{C} = -10 \text{ mA};$ $I_{Bon} = -1 \text{ mA};$	-	-	35	ns
t _{on}	turn-on time	$I_{Boff} = 1 \text{ mA}$	-	-	70	ns
t _s	storage time		-	-	225	ns
t _f	fall time		-	-	75	ns
t _{off}	turn-off time		-	-	300	ns
C _c	collector capacitance	$V_{CB} = -5 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	4.5	pF

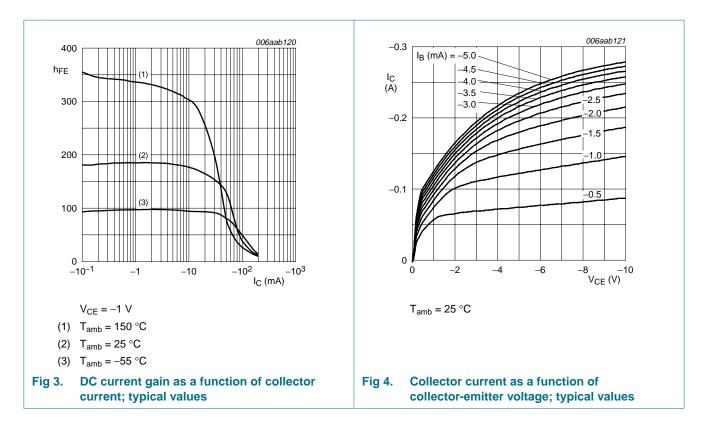
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Product data sheet

40 V, 200 mA PNP switching transistor

Table	7.	Cha	aracte	eristi	cs	continued
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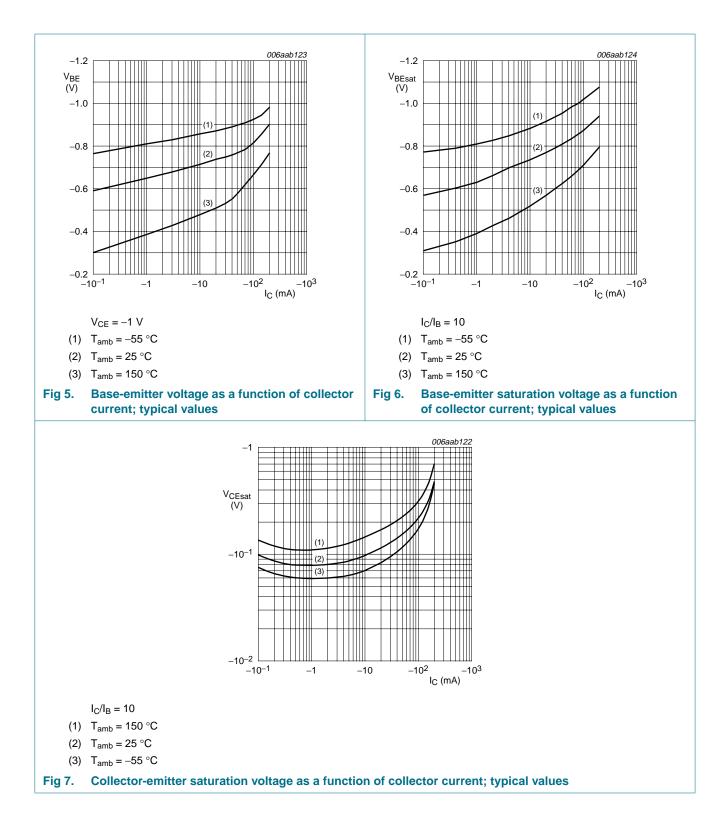
$T_{amb} = 25 ^{\circ}C$ unless otherwise specified.							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
C _e	emitter capacitance	$\label{eq:Veb} \begin{split} V_{EB} &= -500 \text{ mV};\\ I_C &= i_c = 0 \text{ A}; \text{ f} = 1 \text{ MHz} \end{split}$	-	-	10	pF	
f _T	transition frequency	$V_{CE} = -20 \text{ V};$ $I_{C} = -10 \text{ mA};$ f = 100 MHz	250	-	-	MHz	
NF	noise figure		-	-	4	dB	



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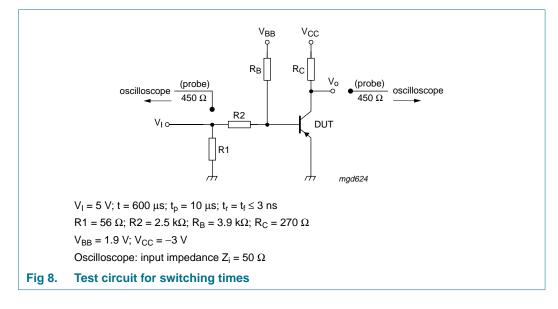
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PMBT3906M_1

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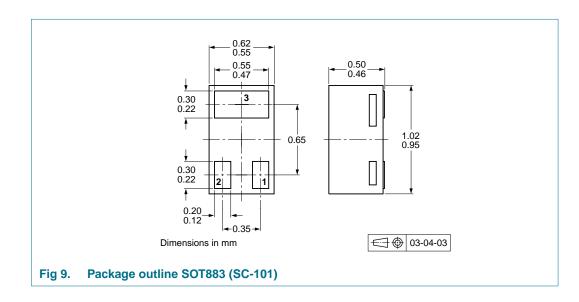
8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



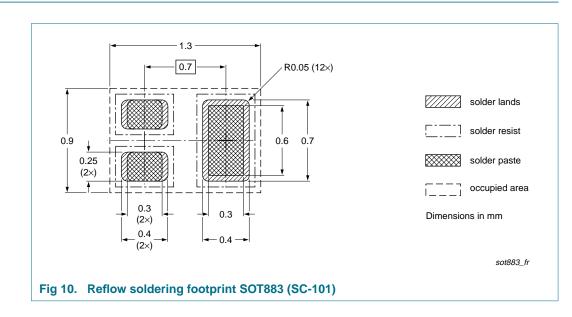
40 V, 200 mA PNP switching transistor

10. Packing information

Table 8. Packing methods The indicated -xxx are the last three digits of the 12NC ordering code.[1]						
Type number	Package	Description	Packing quantity			
			10000			
PMBT3906M	SOT883	2 mm pitch, 8 mm tape and reel	-315			

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

11. Soldering



40 V, 200 mA PNP switching transistor

12. Revision history

Table 9. Revision hi	Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
PMBT3906M_1	20090722	Product data sheet	-	-			

40 V, 200 mA PNP switching transistor

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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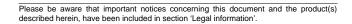
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PMBT3906M_1

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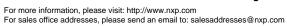
15. Contents

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data1
2	Pinning information 1
3	Ordering information 2
4	Marking
5	Limiting values 2
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 7
8.1	Quality information 7
9	Package outline 7
10	Packing information 8
11	Soldering 8
12	Revision history 9
13	Legal information 10
13.1	Data sheet status 10
13.2	Definitions 10
13.3	Disclaimers
13.4	Trademarks 10
14	Contact information 10
15	Contents 11



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